

## S-82G1A Series

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### CHARGE-DISCHARGE CURRENT PATH SEPARATION CIRCUIT COMPATIBLE BATTERY PROTECTION IC FOR 1-CELL PACK

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Rev.1.0 00

The S-82G1A Series is a protection IC for lithium-ion / lithium polymer rechargeable batteries, which includes high-accuracy voltage detection circuits and delay circuits. It is suitable for protecting 1-cell lithium-ion / lithium polymer rechargeable battery packs from overcharge, overdischarge, and overcurrent.

Using the S-82G1A Series makes it possible to configure a protection circuit which separates the charge and discharge current paths.

Independent charge current path suppresses heat generation during charging.

The S-82G1A Series also has an input pin for charge-discharge control signal, allowing for charge-discharge control with an external signal.

### Features

<ul> <li>High-accuracy voltage detection circuit Overcharge detection voltage Overcharge release voltage Overdischarge detection voltage Overdischarge release voltage Discharge overcurrent detection voltage 1 Discharge overcurrent detection voltage 2 Load short-circuiting detection voltage Charge overcurrent detection voltage</li> <li>Detection delay times are generated only by an internal</li> </ul>	3.500 V to 4.600 V (5 mV step) 3.100 V to 4.600 V <sup>*1</sup> 2.000 V to 3.000 V (10 mV step) 2.000 V to 3.400 V <sup>*2</sup> 0.003 V to 0.100 V (0.5 mV step) 0.010 V to 0.100 V (1 mV step) 0.020 V to 0.100 V (1 mV step) -0.100 V to $-0.010$ V (1 mV step) circuit (external capacitors are unnegative	Accuracy $\pm 15 \text{ mV}$ Accuracy $\pm 50 \text{ mV}$ Accuracy $\pm 50 \text{ mV}$ Accuracy $\pm 75 \text{ mV}$ Accuracy $\pm 1.5 \text{ mV}$ Accuracy $\pm 3 \text{ mV}$ Accuracy $\pm 5 \text{ mV}$ Accuracy $\pm 3 \text{ mV}$ cessary).
<ul> <li>Charge-discharge control function CTL pin control logic is selectable: CTL pin internal resistance connection is selectable: CTL pin internal resistance value is selectable: Charge-discharge inhibition status release function by VM Transition from charge-discharge inhibition status to d</li> </ul>		n MΩ step) able able:
<ul> <li>Discharge overcurrent control function Load short-circuiting detection 2 function is selectable Release condition of discharge overcurrent status: Release voltage of discharge overcurrent status:</li> <li>0 V battery charge function is selectable:</li> <li>Power-down function is selectable:</li> <li>High-withstand voltage:</li> <li>Wide operation temperature range:</li> <li>Low current consumption During operation: During power-down: During overdischarge:</li> <li>Lead-free (Sn 100%), halogen-free</li> </ul>	: Available, unavailable Load disconnection $V_{RIOV} = V_{DD} \times 0.8$ Available, unavailable Available, unavailable VMC pin, VMD pin and CO pin: Abs Ta = -40°C to +85°C 2.0 $\mu$ A typ., 4.0 $\mu$ A max. (Ta = +25° 50 nA max. (Ta = +25°C) 0.5 $\mu$ A max. (Ta = +25°C)	

\*1. Overcharge release voltage = Overcharge detection voltage – Overcharge hysteresis voltage (Overcharge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.4 V in 50 mV step.)
\*2. Overdischarge release voltage = Overdischarge detection voltage + Overdischarge hysteresis voltage

2. Overdischarge release voltage = Overdischarge detection voltage + Overdischarge hysteresis voltage (Overdischarge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.7 V in 100 mV step.)

### Applications

- Lithium-ion rechargeable battery pack
- Lithium polymer rechargeable battery pack
- Package
  - HSNT-8(1616)

#### CHARGE-DISCHARGE CURRENT PATH SEPARATION CIRCUIT COMPATIBLE BATTERY PROTECTION IC FOR 1-CELL PACK S-82G1A Series Rev.1.0\_00

### Block Diagram

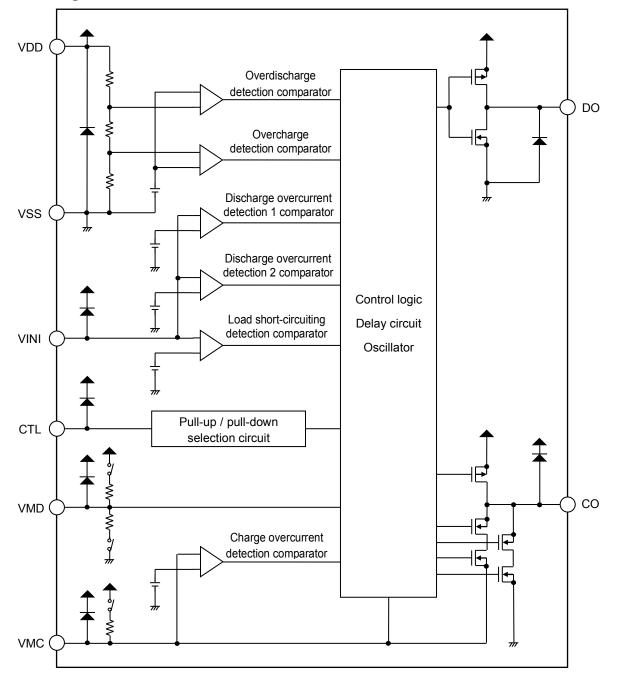
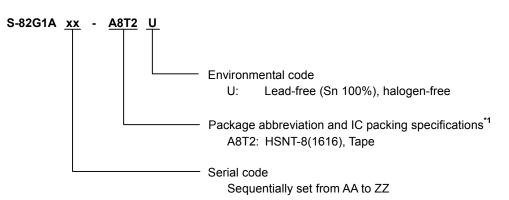


Figure 1

### Product Name Structure

1. Product name



#### \*1. Refer to the tape drawing.

#### 2. Package

Table 1 Package Drawing Codes										
Package Name	Dimension	Таре	Reel	Land						
HSNT-8(1616)	PY008-A-P-SD	PY008-A-C-SD	PY008-A-R-SD	PY008-A-L-SD						

#### 3. Product name list

	Table 2 (1 / 2)											
	Overcharge	Overcharge	Overdischarge	Overdischarge								
Product Name	Detection	Release	Detection	Release	Delay Time	CTL Pin	Function					
FIGUUCINAILE	Voltage	Voltage	Voltage	Voltage	Combination <sup>*1</sup>	Combination <sup>*2</sup>	Combination <sup>*3</sup>					
	[Vcu]	[V <sub>CL</sub> ]	[V <sub>DL</sub> ]	[V <sub>DU</sub> ]								
S-82G1AAA-A8T2U	4.445 V	4.295 V	2.350 V	2.550 V	(1)	(1)	(1)					

#### Table 2 (2 / 2)

Discharge OvercurrentProduct NameDetection Voltage 1		Discharge Overcurrent Detection Voltage 2	Load Short-circuiting Detection Voltage	Charge Overcurrent Detection Voltage	
	[V <sub>DIOV1</sub> ]	[V <sub>DIOV2</sub> ]	[V <sub>SHORT</sub> ]	[V <sub>CIOV</sub> ]	
S-82G1AAA-A8T2U	0.014 V	0.020 V	0.052 V	–0.057 V	

\*1. Refer to **Table 3** about the details of the delay time combinations.

\*2. Refer to Table 5 about the details of CTL pin combinations.

\*3. Refer to Table 6 about the details of function combinations.

Remark Please contact our sales office for products other than the above.

#### CHARGE-DISCHARGE CURRENT PATH SEPARATION CIRCUIT COMPATIBLE BATTERY PROTECTION IC FOR 1-CELL PACK S-82G1A Series Rev.1.0\_00

	Table 3												
Delay Time Combination	Overcharge Detection Delay Time [t <sub>Cu</sub> ]	Overdischarge Detection Delay Time [t <sub>DL</sub> ]	Discharge Overcurrent Detection Delay Time 1 [t <sub>DIOV1</sub> ]	Discharge Overcurrent Detection Delay Time 2 [t <sub>DIOV2</sub> ]	Load Short- circuiting Detection Delay Time [t <sub>SHORT</sub> ]	Charge Overcurrent Detection Delay Time [t <sub>CIOV</sub> ]	Charge- discharge Inhibition Delay Time [t <sub>CTL</sub> ]						
(1)	1.0 s	64 ms	3.75 s	16 ms	280 μs	16 ms	48 ms						

**Remark** The delay times can be changed within the range listed in **Table 4**. For details, please contact our sales office.

Table 4										
Delay Time	Symbol			Selectio	n Range			Remark		
Overcharge detection delay time	t <sub>cu</sub>	256 ms	512 ms	1.0 s	-	_	_	Select a value from the left.		
Overdischarge detection delay time	t <sub>DL</sub>	32 ms	64 ms	128 ms	Ι	_	_	Select a value from the left.		
Discharge overcurrent	4	8 ms	16 ms	32 ms	64 ms	128 ms	256 ms	Select a value		
detection delay time 1	t <sub>DIOV1</sub>	512 ms	1.0 s	2.0 s	3.0 s	3.75 s	4.0 s	from the left.		
Discharge overcurrent detection delay time 2	t <sub>DIOV2</sub>	4 ms	8 ms	16 ms	32 ms	64 ms	128 ms	Select a value from the left.		
Load short-circuiting detection delay time	t <sub>short</sub>	280 μs	530 μs	_	-	_	_	Select a value from the left.		
Charge overcurrent detection delay time	t <sub>CIOV</sub>	4 ms	8 ms	16 ms	32 ms	64 ms	128 ms	Select a value from the left.		
Charge-discharge inhibition delay time	t <sub>CTL</sub>	2 ms	4 ms	48 ms	64 ms	128 ms	256 ms	Select a value from the left.		

#### Table 5

CTL Pin	Control Logic <sup>*1</sup>	Internal Resistance	Internal Resistance Value <sup>*3</sup>	Pin Voltage "H" <sup>*4</sup>	Pin Voltage "L" <sup>*5</sup>
Combination		Connection <sup>*2</sup>	[R <sub>CTL</sub> ]	[V <sub>CTLH</sub> ]	[V <sub>ст⊔L</sub> ]
(1)	Active "H"	Pull-down	5 MΩ	$V_{SS}$ + 0.65 V	$V_{SS}$ + 0.60 V

**\*1.** CTL pin control logic active "H" / active "L" is selectable.

\*2. CTL pin internal resistance connection "pull-up" / "pull-down" is selectable.

\*3. CTL pin internal resistance value is selectable from 1 M $\Omega$  to 10 M $\Omega$  (1 M $\Omega$  step).

\*4. CTL pin voltage "H" is selectable from "V\_{SS} + 0.65 V" / "V\_{DD} - 0.9 V".

\*5. CTL pin voltage "L" is selectable from "V\_{SS} + 0.60 V" / "V\_{DD} - 0.9 V".

**Remark** Please contact our sales office for products other than the above.

		Table 6			
Function Combination	Charge-discharge Inhibition Status Release Function by VMD Pin <sup>*1</sup>	Transition from Charge- discharge Inhibition Status to Discharge Overcurrent Status <sup>*2</sup>	Load Short- circuiting Detection 2 Function <sup>*3</sup>	0 V Battery Charge Function <sup>*4</sup>	Power-down Function <sup>*5</sup>
(1)	Available	Unavailable	Available	Available	Unavailable

\*1. Charge-discharge inhibition status release function by VMD pin "available" / "unavailable" is selectable.

\*2. Transition from charge-discharge inhibition status to discharge overcurrent status "available" / "unavailable" is selectable.

\*3. Load short-circuiting detection 2 function "available" / "unavailable" is selectable.

**\*4.** 0 V battery charge function "available" / "unavailable" is selectable.

**\*5.** Power-down function "available" / "unavailable" is selectable.

**Remark** Please contact our sales office for products other than the above.

## ABLIC Inc.

## Pin Configuration

## 1. HSNT-8(1616)

Top view			Table 7
1 💽 8	Pin No.	Symbol	Description
4 5	1	VMD	Load monitoring pin
4	2	VMC	Negative power supply pin for charge control
Bottom view	3	со	Connection pin of charge control FET gate (CMOS output)
	4	DO	Connection pin of discharge control FET gate (CMOS output)
	5	VSS	Input pin for negative power supply
*1	6	VDD	Input pin for positive power supply
Figure 2	7	VINI	Discharge overcurrent detection pin
	8	CTL	Input pin for charge-discharge control signal

\*1. Connect the heat sink of backside at shadowed area to the board, and set electric potential open or  $V_{DD}$ . However, do not use it as the function of electrode.

### Absolute Maximum Ratings

Table 8

(Ta = +25°C unless otherwise s							
Item	Symbol	Applied Pin	Absolute Maximum Rating	Unit			
Input voltage between VDD pin and VSS pin	V <sub>DS</sub>	VDD	$V_{\rm SS}{-}0.3$ to $V_{\rm SS}{+}6$	V			
VINI pin input voltage	V <sub>VINI</sub>	VINI	$V_{DD} - 6$ to $V_{DD} + 0.3$	V			
CTL pin input voltage	V <sub>CTL</sub>	CTL	$V_{DD} - 6$ to $V_{DD} + 0.3$	V			
VMC pin input voltage	V <sub>VMC</sub>	VMC	$V_{DD} - 28$ to $V_{DD} + 0.3$	V			
VMD pin input voltage	$V_{VMD}$	VMD	$V_{DD} - 28$ to $V_{DD} + 0.3$	V			
DO pin output voltage	V <sub>DO</sub>	DO	$V_{SS} - 0.3$ to $V_{DD} + 0.3$	V			
CO pin output voltage	V <sub>co</sub>	CO	$V_{DD} - 28$ to $V_{DD} + 0.3$	V			
Operation ambient temperature	T <sub>opr</sub>	_	-40 to +85	°C			
Storage temperature	T <sub>stg</sub>	_	–55 to +125	°C			

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

### Thermal Resistance Value

Table 9										
Item	Symbol	Cond	lition	Min.	Тур.	Max.	Unit			
			Board A	-	214	-	°C/W			
	$\theta_{JA}$		Board B	-	172	-	°C/W			
Junction-to-ambient thermal resistance*1		HSNT-8(1616)	Board C	_	1	_	°C/W			
			Board D	_	1	_	°C/W			
			Board E	_	_	_	°C/W			

\*1. Test environment: compliance with JEDEC STANDARD JESD51-2A

**Remark** Refer to "**■ Power Dissipation**" and "**Test Board**" for details.

Table 10

### Electrical Characteristics

1. Ta = +25°C

		Table 10		0500			
ltem	Symbol	Condition	(Ta= Min.	= +25°C un Typ.	lless otherwise Max.	speo Unit	Test
	Cymbol	Condition	101111.	Typ.	Max.	Onit	Circuit
Detection Voltage	1	i					
Overcharge detection voltage	V <sub>CU</sub>	-	V <sub>CU</sub> - 0.015	V <sub>CU</sub>	V <sub>CU</sub> + 0.015	V	1
		$Ta = -20^{\circ}C \text{ to } +60^{\circ}C^{*1}$	V <sub>CU</sub> - 0.020	V <sub>CU</sub>	V <sub>CU</sub> + 0.020	V	1
Overcharge release voltage	V <sub>CL</sub>	$V_{CL} \neq V_{CU}$	$V_{\text{CL}}-0.050$	V <sub>CL</sub>	$V_{CL} + 0.050$	V	1
		V <sub>CL</sub> = V <sub>CU</sub>	$V_{CL} - 0.020$	V <sub>CL</sub>	$V_{CL} + 0.015$	V	1
Overdischarge detection voltage	V <sub>DL</sub>	-	V <sub>DL</sub> - 0.050	V <sub>DL</sub>	$V_{DL} + 0.050$	V	2
Overdischarge release voltage	V <sub>DU</sub>	$V_{DL} \neq V_{DU}$	$V_{DU} - 0.075$	V <sub>DU</sub>	V <sub>DU</sub> + 0.075	V	2
		$V_{DL} = V_{DU}$	$V_{DU} - 0.050$	V <sub>DU</sub>	$V_{DU} + 0.050$	V	2
Discharge overcurrent detection voltage 1	V <sub>DIOV1</sub>	-	$V_{\text{DIOV1}}-0.0015$	V <sub>DIOV1</sub>	$V_{DIOV1} + 0.0015$	V	5
Discharge overcurrent detection voltage 2	V <sub>DIOV2</sub>	-	$V_{DIOV2} - 0.003$	V <sub>DIOV2</sub>	$V_{DIOV2} + 0.003$	V	2
Load short-circuiting detection voltage	VSHORT	-	$V_{\text{SHORT}}-0.005$	VSHORT	$V_{SHORT} + 0.005$	V	2
Load short-circuiting detection voltage 2	$V_{\text{SHORT2}}$	-	V <sub>DD</sub> – 1.2	$V_{\text{DD}}-0.8$	$V_{DD} - 0.5$	V	2
Charge overcurrent detection voltage	V <sub>CIOV</sub>	-	$V_{CIOV} - 0.003$	V <sub>CIOV</sub>	$V_{CIOV} + 0.003$	V	2
Discharge overcurrent release voltage	VRIOV	V <sub>DD</sub> = 3.4 V	$V_{DD}  imes 0.77$	$V_{\text{DD}}\!\times\!0.80$	$V_{\text{DD}} \times 0.83$	V	5
0 V Battery Charge Function	1		r		r	1	
0 V battery charge starting charger voltage	V <sub>0CHA</sub>	0 V battery charge function "available"	0.7	1.3	1.7	۷	4
0 V battery charge inhibition battery voltage	VOINH	0 V battery charge function "unavailable"	0.9	1.2	1.5	۷	2
Internal Resistance	1	1	r	1	r		
Resistance between VDD pin and VMC pin	RVMCD	$V_{DD}$ = 1.8 V, $V_{VMC}$ = 0 V	500	1250	2500	kΩ	3
Resistance between VDD pin and VMD pin	RVMDD	$V_{DD}$ = 1.8 V, $V_{VMD}$ = 0 V	500	1250	2500	kΩ	3
Resistance between VMD pin and VSS pin	RVMDS	$V_{DD}$ = 3.4 V, $V_{VMD}$ = 1.0 V	5	10	15	kΩ	3
CTL pin internal resistance	$R_{\text{CTL}}$	-	$R_{CTL}  imes 0.5$	R <sub>CTL</sub>	$R_{CTL}  imes 2.0$	MΩ	3
Input Voltage			4.5				
Operation voltage between VDD pin and VSS pin	V <sub>DSOP1</sub>	-	1.5	-	6.0	V	-
Operation voltage between VDD pin and VMC pin, VMD pin	V <sub>DSOP2</sub>	-	1.5	-	28	۷	-
CTL pin voltage "H"	V <sub>CTLH</sub>	-	V <sub>CTLH</sub> – 0.3	VCTLH	V <sub>CTLH</sub> + 0.3	V	2
CTL pin voltage "L"	V <sub>CTLL</sub>	-	$V_{\text{CTLL}} - 0.3$	V <sub>CTLL</sub>	$V_{\text{CTLL}} + 0.3$	V	2
Input Current	1		r		r	1	
Current consumption during operation	I <sub>OPE</sub>	$V_{DD} = 3.4 \text{ V},$ $V_{VMC} = V_{VMD} = 0 \text{ V}$	-	2.0	4.0	μA	3
Current consumption during power-down	IPDN	$V_{DD} = V_{VMC} = V_{VMD} = 1.5 V$	-	-	0.05	μA	3
Current consumption during overdischarge	IOPED	$V_{DD}$ = $V_{VMC}$ = $V_{VMD}$ = 1.5 V	-	-	0.5	μA	3
Output Resistance	-		_				
CO pin resistance "H"	R <sub>COH</sub>	-	5	10	20	kΩ	4
CO pin resistance "L"	R <sub>COL</sub>	-	5	10	20	kΩ	4
DO pin resistance "H"	RDOH	-	5	10	20	kΩ	4
DO pin resistance "L" Delay Time	R <sub>DOL</sub>	-	1	2	4	kΩ	4
Overcharge detection delay time	t		$t_{CU}  imes 0.7$	tau	t <sub>cu</sub> × 1.3	_	5
Overdischarge detection delay time	t <sub>cu</sub> t <sub>DL</sub>		$t_{\rm CU} \times 0.7$ $t_{\rm DL} \times 0.7$	t <sub>CU</sub> t <sub>DL</sub>	$t_{DL} \times 1.3$	-	5
· · · ·	UL	_	$t_{DIOV1} \times 0.75$		$t_{DIOV1} \times 1.3$	_	5
Discharge overcurrent detection delay time 1	t <sub>DIOV1</sub>	$Ta = -20^{\circ}C \text{ to } +60^{\circ}C^{*1}$	$t_{\text{DIOV1}}  imes 0.65$	t <sub>DIOV1</sub>	$t_{\text{DIOV1}}  imes 1.35$	-	5
Discharge overcurrent detection delay time 2	t <sub>DIOV2</sub>	-	$t_{DIOV2} \times 0.7$	t <sub>DIOV2</sub>	$t_{DIOV2} \times 1.3$	-	5
Load short-circuiting detection delay time	t <sub>SHORT</sub>	-	t <sub>SHORT</sub> × 0.7	t <sub>SHORT</sub>	t <sub>SHORT</sub> × 1.3	-	5
Charge overcurrent detection delay time	tciov	-	$t_{CIOV} \times 0.7$	tciov	$t_{CIOV} \times 1.3$	-	5
Charge-discharge inhibition delay time	t <sub>CTL</sub>	-	$t_{CTL}  imes 0.7$	t <sub>CTL</sub>	$t_{CTL} \times 1.3$	-	5

\*1. Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

## CHARGE-DISCHARGE CURRENT PATH SEPARATION CIRCUIT COMPATIBLE BATTERY PROTECTION IC FOR 1-CELL PACK S-82G1A Series Rev.1.0\_00

### 2. Ta = $-40^{\circ}$ C to $+85^{\circ}$ C<sup>\*1</sup>

		Table 11	Га = –40°С to	+85°C <sup>*1</sup> un	less otherwise	e spe	cified)
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Detection Voltage	1					1	
Overcharge detection voltage	V <sub>CU</sub>	-	$V_{CU}-0.045$	V <sub>CU</sub>	$V_{CU} + 0.030$	V	1
Oversharze release veltage	V	$V_{CL} \neq V_{CU}$	$V_{CL}-0.080$	V <sub>CL</sub>	$V_{CL} + 0.060$	V	1
Overcharge release voltage	V <sub>CL</sub>	V <sub>CL</sub> = V <sub>CU</sub>	$V_{CL}-0.050$	V <sub>CL</sub>	$V_{CL} + 0.030$	V	1
Overdischarge detection voltage	V <sub>DL</sub>	-	$V_{DL} - 0.080$	V <sub>DL</sub>	V <sub>DL</sub> +0.060	V	2
		V <sub>DL</sub> ≠ V <sub>DU</sub>	$V_{DU} - 0.105$	V <sub>DU</sub>	V <sub>DU</sub> +0.085	V	2
Overdischarge release voltage	$V_{\text{DU}}$	V <sub>DL</sub> = V <sub>DU</sub>	V <sub>DU</sub> - 0.080	V <sub>DU</sub>	V <sub>DU</sub> +0.060	V	2
Discharge overcurrent detection voltage 1	V <sub>DIOV1</sub>	-	V <sub>DIOV1</sub> - 0.002	V <sub>DIOV1</sub>	V <sub>DIOV1</sub> + 0.002	V	5
Discharge overcurrent detection voltage 2	V <sub>DIOV2</sub>	-	V <sub>DIOV2</sub> - 0.003	V <sub>DIOV2</sub>	V <sub>DIOV2</sub> +0.003	V	2
Load short-circuiting detection voltage	VSHORT	-	V <sub>SHORT</sub> - 0.005	VSHORT	V <sub>SHORT</sub> + 0.005	V	2
Load short-circuiting detection voltage 2	V <sub>SHORT2</sub>	-	V <sub>DD</sub> – 1.4	V <sub>DD</sub> - 0.8	$V_{\text{DD}} - 0.3$	V	2
Charge overcurrent detection voltage	V <sub>CIOV</sub>	-	V <sub>CIOV</sub> - 0.003	V <sub>CIOV</sub>	V <sub>CIOV</sub> +0.003	V	2
Discharge overcurrent release voltage	V <sub>RIOV</sub>	V <sub>DD</sub> = 3.4 V	$V_{DD}  imes 0.77$	$V_{\text{DD}} \times 0.80$	$V_{\text{DD}} \times 0.83$	V	5
0 V Battery Charge Function							
0 V battery charge starting charger voltage	V <sub>OCHA</sub>	0 V battery charge function "available"	0.5	1.3	1.9	V	4
0 V battery charge inhibition battery voltage	Voinh	0 V battery charge function "unavailable"	0.7	1.2	1.7	V	2
Internal Resistance							
Resistance between VDD pin and VMC pin	RVMCD	V <sub>DD</sub> = 1.8 V, V <sub>VMC</sub> = 0 V	250	1250	3500	kΩ	3
Resistance between VDD pin and VMD pin	RVMDD	V <sub>DD</sub> = 1.8 V, V <sub>VMD</sub> = 0 V	250	1250	3500	kΩ	3
Resistance between VMD pin and VSS pin	R <sub>VMDS</sub>	V <sub>DD</sub> = 3.4 V, V <sub>VMD</sub> = 1.0 V	3.5	10	20	kΩ	3
CTL pin internal resistance	R <sub>CTL</sub>	-	$R_{CTL}  imes 0.25$	R <sub>CTL</sub>	$R_{CTL} \times 3.0$	MΩ	3
Input Voltage							
Operation voltage between VDD pin and VSS pin	V <sub>DSOP1</sub>	-	1.5	-	6.0	V	-
Operation voltage between VDD pin and VMC pin,			1 5		28	v	
VMD pin	V <sub>DSOP2</sub>	-	1.5	-	28	v	-
CTL pin voltage "H"	V <sub>CTLH</sub>	-	$V_{\text{CTLH}} - 0.4$	V <sub>CTLH</sub>	$V_{\text{CTLH}} + 0.4$	V	2
CTL pin voltage "L"	V <sub>CTLL</sub>	-	$V_{\text{CTLL}} - 0.4$	V <sub>CTLL</sub>	$V_{\text{CTLL}} + 0.4$	V	2
Input Current						-	
Current consumption during operation	I <sub>OPE</sub>	$V_{DD}$ = 3.4 V, $V_{VMC}$ = $V_{VMD}$ = 0 V	_	2.0	5.0	μA	3
Current consumption during power-down	IPDN	$V_{DD} = V_{VMC} = V_{VMD} = 1.5 V$	-	-	0.1	μA	3
Current consumption during overdischarge	IOPED	$V_{DD} = V_{VMC} = V_{VMD} = 1.5 V$	-	-	1.0	μA	3
Output Resistance							
CO pin resistance "H"	RCOH	-	2.5	10	30	kΩ	4
CO pin resistance "L"	R <sub>COL</sub>	-	2.5	10	30	kΩ	4
DO pin resistance "H"	R <sub>DOH</sub>	-	2.5	10	30	kΩ	4
DO pin resistance "L"	R <sub>DOL</sub>	-	0.5	2	6	kΩ	4
Delay Time			·		·		
Overcharge detection delay time	t <sub>CU</sub>	-	$t_{CU}  imes 0.4$	t <sub>cu</sub>	$t_{CU}  imes 1.6$	-	5
Overdischarge detection delay time	t <sub>DL</sub>	-	$t_{\text{DL}} \times 0.4$	t <sub>DL</sub>	$t_{DL}  imes 1.6$	-	5
Discharge overcurrent detection delay time 1	t <sub>DIOV1</sub>	-	$t_{\text{DIOV1}}  imes 0.4$	t <sub>DIOV1</sub>	$t_{\text{DIOV1}} \times 1.6$	-	5
Discharge overcurrent detection delay time 2	t <sub>DIOV2</sub>	-	$t_{\text{DIOV2}} \times 0.4$	t <sub>DIOV2</sub>	$t_{\text{DIOV2}} \times 1.6$	-	5
Load short-circuiting detection delay time	<b>t</b> SHORT	-	$t_{\text{SHORT}}  imes 0.4$	<b>t</b> SHORT	$t_{\text{SHORT}}  imes 1.6$	-	5
Charge overcurrent detection delay time	t <sub>CIOV</sub>	-	$t_{\text{CIOV}} \times 0.4$	t <sub>ciov</sub>	$t_{CIOV}  imes 1.6$	-	5
Charge-discharge inhibition delay time	t <sub>CTL</sub>	-	$t_{\text{CTL}}  imes 0.4$	t <sub>CTL</sub>	$t_{\text{CTL}}  imes 1.6$	-	5

\*1. Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.

### Test Circuits

When CTL pin control logic is active "H", SW1 and SW3 are turned off, SW2 and SW4 are turned on. When CTL pin control logic is active "L", SW1 and SW3 are turned on, SW2 and SW4 are turned off.

Caution Unless otherwise specified, the output voltage levels "H" and "L" at CO pin ( $V_{CO}$ ) and DO pin ( $V_{DO}$ ) are judged by the threshold voltage (1.0 V) of the N-channel FET. Judge the CO pin level with respect to  $V_{VMC}$  and the DO pin level with respect to  $V_{SS}$ .

## 1. Overcharge detection voltage, overcharge release voltage (Test circuit 1)

Overcharge detection voltage ( $V_{CU}$ ) is defined as the voltage V1 at which  $V_{CO}$  goes from "H" to "L" when the voltage V1 is gradually increased after setting V1 = 3.4 V. Overcharge release voltage ( $V_{CL}$ ) is defined as the voltage V1 at which  $V_{CO}$  goes from "L" to "H" when the voltage V1 is then gradually decreased. Overcharge hysteresis voltage ( $V_{HC}$ ) is defined as the difference between  $V_{CU}$  and  $V_{CL}$ .

## 2. Overdischarge detection voltage, overdischarge release voltage (Test circuit 2)

Overdischarge detection voltage ( $V_{DL}$ ) is defined as the voltage V1 at which  $V_{DO}$  goes from "H" to "L" when the voltage V1 is gradually decreased after setting V1 = 3.4 V, V2 = V5 = V6 = V7 = 0 V. Overdischarge release voltage ( $V_{DU}$ ) is defined as the voltage V1 at which  $V_{DO}$  goes from "L" to "H" when setting V2 = 0.01 V, V5 = V6 = V7 = 0 V and when the voltage V1 is then gradually increased. Overdischarge hysteresis voltage ( $V_{HD}$ ) is defined as the difference between  $V_{DU}$  and  $V_{DL}$ .

## 3. Discharge overcurrent detection voltage 1, discharge overcurrent release voltage (Test circuit 5)

Discharge overcurrent detection voltage 1 ( $V_{DIOV1}$ ) is defined as the voltage V5 whose delay time for changing  $V_{DO}$  from "H" to "L" is discharge overcurrent detection delay time 1 ( $t_{DIOV1}$ ) when the voltage V5 is increased after setting V1 = 3.4 V, V2 = V5 = V7 = 0 V, V6 = 1.4 V. Discharge overcurrent release voltage ( $V_{RIOV}$ ) is defined as the voltage V6 at which  $V_{DO}$  goes from "L" to "H" when setting V5 = 0 V, V6 = 3.4 V and when the voltage V6 is then gradually decreased.

When the voltage V6 falls below  $V_{RIOV}$ ,  $V_{DO}$  will go to "H" after 1.0 ms typ. and maintain "H" during load short-circuiting detection delay time ( $t_{SHORT}$ ).

## 4. Discharge overcurrent detection voltage 2 (Test circuit 2)

Discharge overcurrent detection voltage 2 ( $V_{DIOV2}$ ) is defined as the voltage V5 whose delay time for changing  $V_{DO}$  from "H" to "L" is discharge overcurrent detection delay time 2 ( $t_{DIOV2}$ ) when the voltage V5 is increased after setting V1 = 3.4 V, V2 = V5 = V7 = 0 V, V6 = 1.4 V.

## 5. Load short-circuiting detection voltage (Test circuit 2)

Load short-circuiting detection voltage ( $V_{SHORT}$ ) is defined as the voltage V5 whose delay time for changing  $V_{DO}$  from "H" to "L" is  $t_{SHORT}$  when the voltage V5 is increased after setting V1 = 3.4 V, V2 = V5 = V7 = 0 V, V6 = 1.4 V.

## 6. Load short-circuiting detection voltage 2 (Test circuit 2)

Load short-circuiting detection voltage 2 ( $V_{SHORT2}$ ) is defined as the voltage V6 whose delay time for changing  $V_{DO}$  from "H" to "L" is  $t_{SHORT}$  when the voltage V6 is increased after setting V1 = 3.4 V, V2 = V5 = V6 = V7 = 0 V.

## 7. Charge overcurrent detection voltage (Test circuit 2)

Charge overcurrent detection voltage ( $V_{CIOV}$ ) is defined as the voltage V2 whose delay time for changing  $V_{CO}$  from "H" to "L" is charge overcurrent detection delay time ( $t_{CIOV}$ ) when the voltage V2 is decreased after setting V1 = 3.4 V, V2 = V5 = V6 = V7 = 0 V.

#### 8. CTL pin voltage "H", CTL pin voltage "L" (Test circuit 2)

#### 8.1 CTL pin control logic active "H"

The CTL pin voltage "H" (V<sub>CTLH</sub>) is defined as the voltage V7 at which V<sub>CO</sub> and V<sub>DO</sub> go from "H" to "L" when the voltage V7 is gradually increased after setting V1 = 3.4 V, V2 = V5 = V7 = 0 V, V6 = -0.5 V. After that, the CTL pin voltage "L" (V<sub>CTLL</sub>) is defined as the voltage V7 at which V<sub>CO</sub> and V<sub>DO</sub> go from "L" to "H" after V7 is gradually decreased.

#### 8. 2 CTL pin control logic active "L"

 $V_{CTLL}$  is defined as the voltage difference between the voltage V7 and the voltage V1 (V1 – V7) at which  $V_{CO}$  and  $V_{DO}$  go from "H" to "L" when the voltage V7 is gradually increased after setting V1 = 3.4 V, V2 = V5 = V6 = V7 = 0 V. After that,  $V_{CTLH}$  is defined as V1 – V7 at which  $V_{CO}$  and  $V_{DO}$  go from "L" to "H" after V7 is gradually decreased.

## 9. Current consumption during operation (Test circuit 3)

The current consumption during operation ( $I_{OPE}$ ) is the current that flows through the VDD pin ( $I_{DD}$ ) under the set conditions of V1 = 3.4 V, V2 = V5 = V6 = V7 = 0 V. However, the current flowing through the CTL pin internal resistance is excluded.

## 10. Current consumption during power-down, current consumption during overdischarge (Test circuit 3)

#### 10.1 With power-down function

The current consumption during power-down ( $I_{PDN}$ ) is  $I_{DD}$  under the set conditions of V1 = V2 = V6 = 1.5 V, V5 = V7 = 0 V.

#### 10. 2 Without power-down function

The current consumption during overdischarge ( $I_{OPED}$ ) is  $I_{DD}$  under the set conditions of V1 = V2 = V6 = 1.5 V, V5 = V7 = 0 V.

## 11. Resistance between VDD pin and VMC pin (Test circuit 3)

 $R_{VMCD}$  is the resistance between VDD pin and VMC pin under the set conditions of V1 = 1.8 V, V2 = V5 = V6 = V7 = 0 V.

## 12. Resistance between VDD pin and VMD pin (Test circuit 3)

 $R_{VMDD}$  is the resistance between VDD pin and VMD pin under the set conditions of V1 = 1.8 V, V2 = V5 = V6 = V7 = 0 V.

## 13. Resistance between VMD pin and VSS pin (Test circuit 3)

 $R_{VMDS}$  is the resistance between VMD pin and VSS pin when the voltage V5 is decreased to 0 V after setting V1 = 3.4 V, V2 = V7 = 0 V, V5 = V6 = 1.0 V.

## 14. CTL pin internal resistance (Test circuit 3)

#### 14. 1 CTL pin control logic active "H" and CTL pin internal resistance connection "pull-up"

CTL pin internal resistance ( $R_{CTL}$ ) is the resistance between CTL pin and VDD pin under the set conditions of V1 = 3.4 V, V2 = V5 = V6 = V7 = 0 V.

#### 14. 2 CTL pin control logic active "H" and CTL pin internal resistance connection "pull-down"

 $R_{CTL}$  is the resistance between CTL pin and VSS pin under the set conditions of V1 = V7 = 3.4 V, V2 = V5 = V6 = 0 V.

#### 14. 3 CTL pin control logic active "L" and CTL pin internal resistance connection "pull-up"

 $R_{CTL}$  is the resistance between CTL pin and VDD pin under the set conditions of V1 = V7 = 3.4 V, V2 = V5 = V6 = 0 V.

#### 14. 4 CTL pin control logic active "L" and CTL pin internal resistance connection "pull-down"

 $R_{CTL}$  is the resistance between CTL pin and VSS pin under the set conditions of V1 = 3.4 V, V2 = V5 = V6 = V7 = 0 V.

#### 15. CO pin resistance "H" (Test circuit 4)

The CO pin resistance "H" ( $R_{COH}$ ) is the resistance between VDD pin and CO pin under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V, V3 = 3.0 V.

#### 16. CO pin resistance "L" (Test circuit 4)

The CO pin resistance "L" ( $R_{COL}$ ) is the resistance between VMC pin and CO pin under the set conditions of V1 = 4.7 V, V2 = V5 = 0 V, V3 = 0.4 V.

#### 17. DO pin resistance "H" (Test circuit 4)

The DO pin resistance "H" ( $R_{DOH}$ ) is the resistance between VDD pin and DO pin under the set conditions of V1 = 3.4 V, V2 = V5 = 0 V, V4 = 3.0 V.

#### 18. DO pin resistance "L" (Test circuit 4)

The DO pin resistance "L" ( $R_{DOL}$ ) is the resistance between VSS pin and DO pin under the set conditions of V1 = 1.8 V, V2 = V5 = 0 V, V4 = 0.4 V.

#### 19. Overcharge detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = V6 = V7 = 0 V, the voltage V1 is increased. The time interval from when the voltage V1 exceeds  $V_{CU}$  until  $V_{CO}$  goes to "L" is the overcharge detection delay time ( $t_{CU}$ ).

#### 20. Overdischarge detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = V6 = V7 = 0 V, the voltage V1 is decreased. The time interval from when the voltage V1 falls below  $V_{DL}$  until  $V_{DO}$  goes to "L" is the overdischarge detection delay time ( $t_{DL}$ ).

## 21. Discharge overcurrent detection delay time 1 (Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = V7 = 0 V, V6 = 1.4 V, the voltage V5 is increased. The time interval from when the voltage V5 exceeds  $V_{DIOV1}$  until  $V_{DO}$  goes to "L" is the discharge overcurrent detection delay time 1 ( $t_{DIOV1}$ ).

## 22. Discharge overcurrent detection delay time 2 (Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = V7 = 0 V, V6 = 1.4 V, the voltage V5 is increased. The time interval from when the voltage V5 exceeds  $V_{DIOV2}$  until  $V_{DO}$  goes to "L" is the discharge overcurrent detection delay time 2 ( $t_{DIOV2}$ ).

## 23. Load short-circuiting detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = V7 = 0 V, V6 = 1.4 V, the voltage V5 is increased. The time interval from when the voltage V5 exceeds  $V_{SHORT}$  until  $V_{DO}$  goes to "L" is the load short-circuiting detection delay time ( $t_{SHORT}$ ).

## 24. Charge overcurrent detection delay time (Test circuit 5)

After setting V1 = 3.4 V, V2 = V5 = V6 = V7 = 0 V, the voltage V2 is decreased. The time interval from when the voltage V2 falls below  $V_{CIOV}$  until  $V_{CO}$  goes to "L" is the charge overcurrent detection delay time ( $t_{CIOV}$ ).

## 25. Charge-discharge inhibition delay time (Test circuit 5)

#### 25.1 CTL pin control logic active "H"

After setting V1 = 3.4 V, V2 = V5 = V7 = 0 V, V6 = -0.5 V, the voltage V7 is increased. The time interval from when the voltage V7 exceeds V<sub>CTLH</sub> until V<sub>CO</sub> and V<sub>DO</sub> go to "L" is the charge-discharge inhibition delay time (t<sub>CTL</sub>).

#### 25. 2 CTL pin control logic active "L"

After setting V1 = 3.4 V, V2 = V5 = V6 = V7 = 0 V, the voltage V7 is increased. The time interval from when the voltage V1 – V7 falls below  $V_{CTLL}$  until  $V_{CO}$  and  $V_{DO}$  go to "L" is  $t_{CTL}$ .

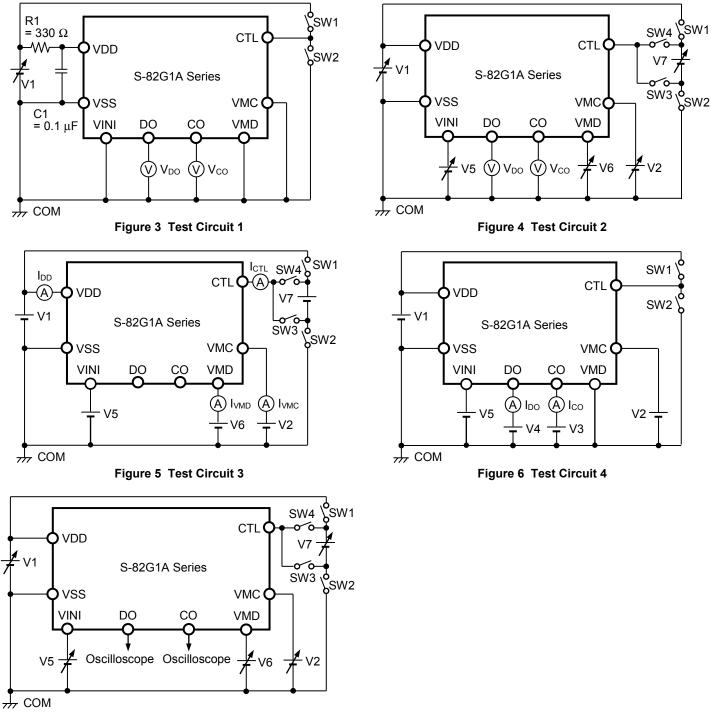
## 26. 0 V battery charge starting charger voltage (0 V battery charge function "available") (Test circuit 4)

The 0 V battery charge starting charger voltage ( $V_{0CHA}$ ) is defined as the absolute value of voltage V2 at which the current flowing through the CO pin ( $I_{CO}$ ) exceeds 1.0  $\mu$ A when the voltage V2 is gradually decreased after setting V1 = V5 = 0 V, V2 = V3 = -0.5 V.

## 27. 0 V battery charge inhibition battery voltage (0 V battery charge function "unavailable") (Test circuit 2)

The 0 V battery charge inhibition battery voltage ( $V_{0INH}$ ) is defined as the voltage V1 at which  $V_{CO}$  goes to "L" ( $V_{CO} = V_{VM}$ ) when the voltage V1 is gradually decreased after setting V1 = 1.8 V, V2 = -2.0 V, V5 = V6 = V7 = 0 V.

### CHARGE-DISCHARGE CURRENT PATH SEPARATION CIRCUIT COMPATIBLE BATTERY PROTECTION IC FOR 1-CELL PACK Rev.1.0\_00 S-82G1A Series





### Operation

**Remark** Refer to "
Battery Protection IC Connection Example".

#### 1. Normal status

The S-82G1A Series monitors the voltage of the battery connected between VDD pin and VSS pin, the voltage between VINI pin and VSS pin, the voltage between VMC pin and VSS pin and the voltage between CTL pin and VSS pin to control charging and discharging.

#### 1.1 CTL pin control logic active "H"

When the battery voltage is in the range from overdischarge detection voltage ( $V_{DL}$ ) to overcharge detection voltage ( $V_{CU}$ ), the VINI pin voltage is equal to or lower than the discharge overcurrent detection voltage 1 ( $V_{DIOV1}$ ), the VMC pin voltage is equal to or higher than the charge overcurrent detection voltage ( $V_{CIOV}$ ), and the CTL pin voltage is equal to or lower than the CTL pin voltage "L" ( $V_{CTLL}$ ), the S-82G1A Series turns both the charge and discharge control FETs on. This condition is called the normal status, and in this condition charging and discharging can be carried out freely.

The resistance between VDD pin and VMC pin ( $R_{VMCD}$ ), the resistance between VDD pin and VMD pin ( $R_{VMDD}$ ), and the resistance between VMD pin and VSS pin ( $R_{VMDS}$ ) are not connected in the normal status.

#### 1.2 CTL pin control logic active "L"

When the battery voltage is in the range from  $V_{DL}$  to  $V_{CU}$ , the VINI pin voltage is equal to or lower than  $V_{DIOV1}$ , the VMC pin voltage is equal to or higher than the charge overcurrent detection voltage ( $V_{CIOV}$ ), and the CTL pin voltage is equal to or higher than CTL pin voltage "H" ( $V_{CTLH}$ ), the S-82G1A Series turns both the charge and discharge control FETs on. This condition is called the normal status, and in this condition charging and discharging can be carried out freely.

 $R_{VMCD}$ ,  $R_{VMDD}$  and  $R_{VMDS}$  are not connected in the normal status.

#### 2. Overcharge status

#### 2. 1 $V_{CL} \neq V_{CU}$ (Product in which overcharge release voltage differs from overcharge detection voltage)

When the battery voltage becomes higher than  $V_{CU}$  during charging in the normal status and the condition continues for the overcharge detection delay time ( $t_{CU}$ ) or longer, the S-82G1A Series turns the charge control FET off to stop charging. This condition is called the overcharge status.

The overcharge status is released in the following two cases.

- (1) In the case that the VMC pin voltage is lower than 0.35 V typ., the S-82G1A Series releases the overcharge status when the battery voltage falls below overcharge release voltage (V<sub>CL</sub>).
- (2) In the case that the VMC pin voltage is equal to or higher than 0.35 V typ., the S-82G1A Series releases the overcharge status when the battery voltage falls below  $V_{CU}$ .

Even if the battery voltage exceeds  $V_{CU}$ , discharge overcurrent detection and load short-circuiting detection will function.

# Caution If the battery is charged to a voltage higher than $V_{CU}$ and the battery voltage does not fall below $V_{CU}$ even when a load is erroneously connected to the CHA– pin, the discharge current will continue to flow until the battery voltage falls below $V_{CU}$ .

#### 2. 2 $V_{CL} = V_{CU}$ (Product in which overcharge release voltage is the same as overcharge detection voltage)

When the battery voltage becomes higher than  $V_{CU}$  during charging in the normal status and the condition continues for  $t_{CU}$  or longer, the S-82G1A Series turns the charge control FET off to stop charging. This condition is called the overcharge status.

In the case that the VMC pin voltage is equal to or higher than 0 V typ. and the battery voltage falls below  $V_{CU}$ , the S-82G1A Series releases the overcharge status.

Even if the battery voltage exceeds the  $V_{CU}$ , discharge overcurrent detection and load short-circuiting detection will function.

- Caution 1. If the battery is charged to a voltage higher than  $V_{CU}$  and the battery voltage does not fall below  $V_{CU}$  even when a load is erroneously connected to the CHA– pin, the discharge current will continue to flow until the battery voltage falls below  $V_{CU}$ .
  - 2. When a charger is connected after overcharge detection, the overcharge status is not released even if the battery voltage is below  $V_{CL}$ . The overcharge status is released when the VMC pin voltage goes over 0 V typ. by removing the charger.

#### 3. Overdischarge status

When the battery voltage falls below  $V_{DL}$  during discharging in the normal status and the condition continues for the overdischarge detection delay time ( $t_{DL}$ ) or longer, the S-82G1A Series turns the discharge control FET off to stop discharging. This condition is called the overdischarge status.

Under the overdischarge status, the VDD pin and VMC pin are shorted by  $R_{VMCD}$ , and the VDD pin and VMD pin are shorted by  $R_{VMDD}$  in the S-82G1A Series. The VMC pin and VMD pin voltages are pulled up by  $R_{VMCD}$  and  $R_{VMDD}$  respectively.

When connecting a charger in the overdischarge status, the battery voltage reaches  $V_{DL}$  or higher and the S-82G1A Series releases the overdischarge status if the VMC pin voltage falls below 0 V typ.

The battery voltage reaches the overdischarge release voltage ( $V_{DU}$ ) or higher and the S-82G1A Series releases the overdischarge status if the VMC pin voltage does not fall below 0 V typ.

R<sub>VMDS</sub> is not connected in the overdischarge status.

#### 3.1 With power-down function

Under the overdischarge status, when voltage difference between VDD pin and VMC pin is 0.8 V typ. or lower, the power-down function works and the current consumption is reduced to the current consumption during power-down ( $I_{PDN}$ ). By connecting a battery charger, the power-down function is released when the VMC pin voltage is 0.7 V typ. or lower.

- When a battery is not connected to a charger and the VMC pin voltage ≥ 0.7 V typ., the S-82G1A Seies maintains the overdischarge status even when the battery voltage reaches V<sub>DU</sub> or higher.
- When a battery is connected to a charger and 0.7 V typ. > the VMC pin voltage > 0 V typ., the battery voltage reaches V<sub>DU</sub> or higher and the S-82G1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VMC pin voltage, the battery voltage reaches V<sub>DL</sub> or higher and the S-82G1A Series releases the overdischarge status.

#### 3. 2 Without power-down function

Under the overdischarge status, the power-down function does not work even when voltage difference between VDD pin and VMC pin is 0.8 V typ. or lower.

- When a battery is not connected to a charger and the VMC pin voltage ≥ 0.7 V typ., the battery voltage reaches V<sub>DU</sub> or higher and the S-82G1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0.7 V typ. > the VMC pin voltage > 0 V typ., the battery voltage reaches V<sub>DU</sub> or higher and the S-82G1A Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. ≥ the VMC pin voltage, the battery voltage reaches V<sub>DL</sub> or higher and the S-82G1A Series releases the overdischarge status.

#### 4. Discharge overcurrent status (Discharge overcurrent 1, discharge overcurrent 2, load shortcircuiting, load short-circuiting 2)

#### 4.1 Discharge overcurrent 1, discharge overcurrent 2, load short-circuiting

When a battery in the normal status or the overcharge status is in the status where the VINI pin voltage is equal to or higher than  $V_{DIOV1}$  because the discharge current is equal to or higher than the specified value and the status lasts for the discharge overcurrent detection delay time 1 ( $t_{DIOV1}$ ) or longer, the discharge control FET is turned off and discharging is stopped. This status is called the discharge overcurrent status.

Under the discharge overcurrent status, VMD pin and VSS pin are shorted by  $R_{VMDS}$  in the S-82G1A Series. However, the VMD pin voltage is the VDD pin voltage due to the load as long as the load is connected. When the load is disconnected, VMD pin voltage returns to the VSS pin voltage.

When the VMD pin voltage returns to  $V_{RIOV}$  or lower, the S-82G1A Series releases the discharge overcurrent status.

 $R_{\text{VMDD}}$  is not connected in the discharge overcurrent status.

#### 4. 2 Load short-circuiting 2

When a battery in the normal status or the overcharge status is in the status where a load causing discharge overcurrent is connected, and the VMD pin voltage is equal to or higher than  $V_{SHORT2}$  and the status lasts for the load short-circuiting detection delay time ( $t_{SHORT}$ ) or longer, the discharge control FET is turned off and discharging is stopped. The S-82G1A Series then becomes discharge overcurrent status.

The S-82G1A Series releases the discharge overcurrent status in the same way as in "4. 1 Discharge overcurrent 1, discharge overcurrent 2, load short-circuiting".

#### 5. Charge overcurrent status

When a battery in the normal status is in the status where the VMC pin voltage is equal to or lower than  $V_{CIOV}$  because the charge current is equal to or higher than the specified value and the status lasts for the charge overcurrent detection delay time ( $t_{CIOV}$ ) or longer, the charge control FET is turned off and charging is stopped. This status is called the charge overcurrent status.

The charge overcurrent status is released when the VMC pin voltage goes over 0 V typ. by removing the charger. The charge overcurrent detection does not function in the overdischarge status.

#### 6. Charge-discharge inhibition status

#### 6. 1 CTL pin control logic active "H"

When the CTL pin voltage is equal to or higher than CTL pin voltage "H" ( $V_{CTLH}$ ) and the status lasts for the charge-discharge inhibition delay time ( $t_{CTL}$ ) or longer, the charge control FET and the discharge control FET are turned off, and charging and discharging are stopped. This status is called the charge-discharge inhibition status.

The S-82G1A Series releases charge-discharge inhibition status when the CTL pin voltage is equal to or lower than CTL pin voltage "L" ( $V_{CTLL}$ ).

#### 6. 2 CTL pin control logic active "L"

When the CTL pin voltage is equal to or lower than  $V_{CTLL}$  and the status lasts for  $t_{CTL}$  or longer, the charge control FET and the discharge control FET are turned off, and charging and discharging are stopped. This status is called the charge-discharge inhibition status.

The S-82G1A Series releases charge-discharge inhibition status when the CTL pin voltage is equal to or higher than  $V_{CTLH}$ .

#### 6.3 CTL pin internal resistance connection

#### 6. 3. 1 CTL pin internal resistance connection "pull-up"

The CTL pin is shorted to the VDD pin by the CTL pin internal resistance (R<sub>CTL</sub>).

#### 6. 3. 2 CTL pin internal resistance connection "pull-down"

The CTL pin is shorted to the VSS pin by  $R_{CTL}$ .

When the S-82G1A Series becomes overdischarge status,  $R_{CTL}$  is disconnected, and the input current and the output current to the CTL pin are cut off.

The charge-discharge control by the CTL pin does not function in the overdischarge status.

#### 6. 4 Charge-discharge inhibition status release function by VMD pin

#### 6. 4. 1 Charge-discharge inhibition status release function by VMD pin "available"

The S-82G1A Series releases the charge-discharge inhibition status when the VMD pin voltage rises.

#### 6. 4. 2 Charge-discharge inhibition status release function by VMD pin "unavailable"

The S-82G1A Series does not release the charge-discharge inhibition status even when the VMD pin voltage rises.

#### 6.5 Transition from charge-discharge inhibition status to discharge overcurrent status

#### 6. 5. 1 Transition from charge-discharge inhibition status to discharge overcurrent status "available"

The S-82G1A Series becomes the discharge overcurrent status when the VMD pin voltage is equal to or higher than  $V_{SHORT2}$  and the condition continues for the load short-circuiting detection delay time ( $t_{SHORT}$ ) or longer.

#### 6. 5. 2 Transition from charge-discharge inhibition status to discharge overcurrent status "unavailable"

The S-82G1A Series does not become the discharge overcurrent status and maintains the charge-discharge inhibition status even when the VMD pin voltage is equal to or higher than  $V_{SHORT2}$  and the condition continues for  $t_{SHORT}$  or longer.

#### 7. Discharge current stop function in charge current path

When the discharge current flows to charge current path because a load is erroneously connected to a charge pin in a battery in the normal status, and the time at which the VMC pin voltage is equal to or higher than 7 mV typ. lasts for the load short-circuiting detection delay time ( $t_{SHORT}$ ) or longer, the discharge current is stopped by changing the gate potential of charge control FET to the V<sub>SS</sub> potential.

In this status, the VDD pin and VMC pin are shorted by  $R_{VMCD}$  in the S-82G1A Series. The VMC pin voltage is pulled up by  $R_{VMCD}$ .

The S-82G1A Series returns to the normal status once the VMC pin voltage falls below 7 mV typ. by disconnecting a load and connecting a charger.

#### 8. 0 V battery charge function "available"

This function is used to recharge a connected battery whose voltage is 0 V due to self-discharge. When the 0 V battery charge starting charger voltage ( $V_{0CHA}$ ) or a higher voltage is applied between the EB+ and CHA- pins by connecting a charger, the charge control FET gate is fixed to the VDD pin voltage.

When the voltage between the gate and source of the charge control FET becomes equal to or higher than the threshold voltage due to the charger voltage, the charge control FET is turned on to start charging. At this time, the discharge control FET is off and the charging current flows through the internal parasitic diode in the discharge control FET. When the battery voltage becomes equal to or higher than  $V_{DL}$ , the S-82G1A Series returns to the normal status.

- Caution 1. Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. Please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge function.
  - 2. The 0 V battery charge function has higher priority than the charge overcurrent detection function. Consequently, a product in which use of the 0 V battery charge function is enabled charges a battery forcibly and the charge overcurrent cannot be detected when the battery voltage is lower than  $V_{DL}$ .

#### 9. 0 V battery charge function "unavailable"

This function inhibits charging when a battery that is internally short-circuited (0 V battery) is connected. When the battery voltage is the 0 V battery charge inhibition battery voltage ( $V_{0INH}$ ) or lower, the charge control FET gate is fixed to the CHA- pin voltage to inhibit charging. When the battery voltage is  $V_{0INH}$  or higher, charging can be performed.

Caution Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. Please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge function.

### 10. Delay circuit

The detection delay times are determined by dividing a clock of approximately 4 kHz by the counter.

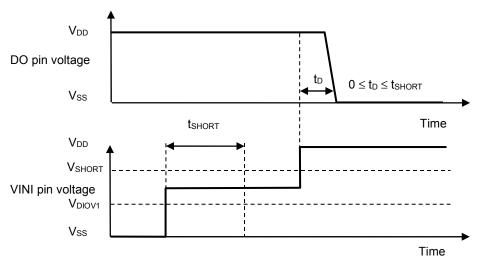
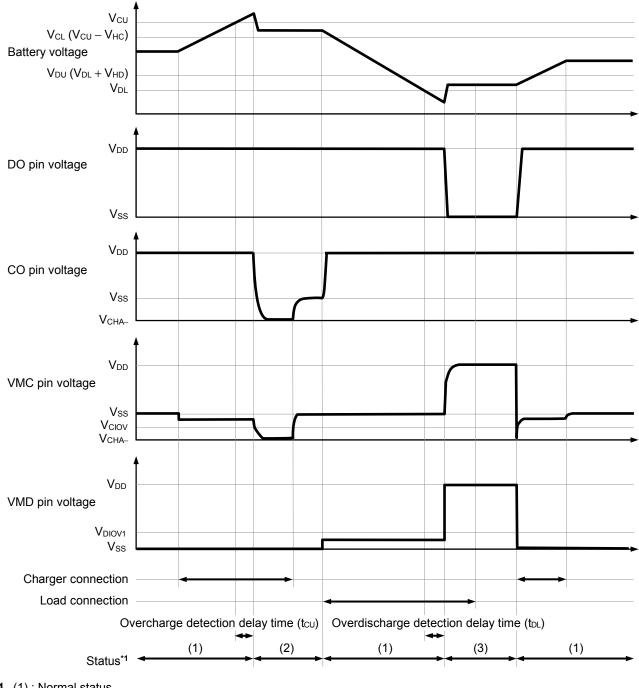


Figure 8

### Timing Charts

### 1. Overcharge detection, overdischarge detection



\*1. (1) : Normal status

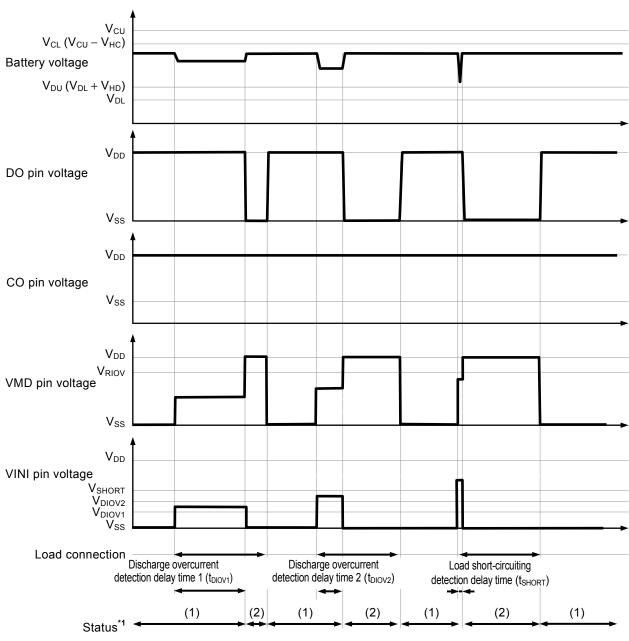
(2) : Overcharge status

(3) : Overdischarge status

Remark The charger is assumed to charge with a constant current.

Figure 9

## CHARGE-DISCHARGE CURRENT PATH SEPARATION CIRCUIT COMPATIBLE BATTERY PROTECTION IC FOR 1-CELL PACK Rev.1.0\_00 S-82G1A Series



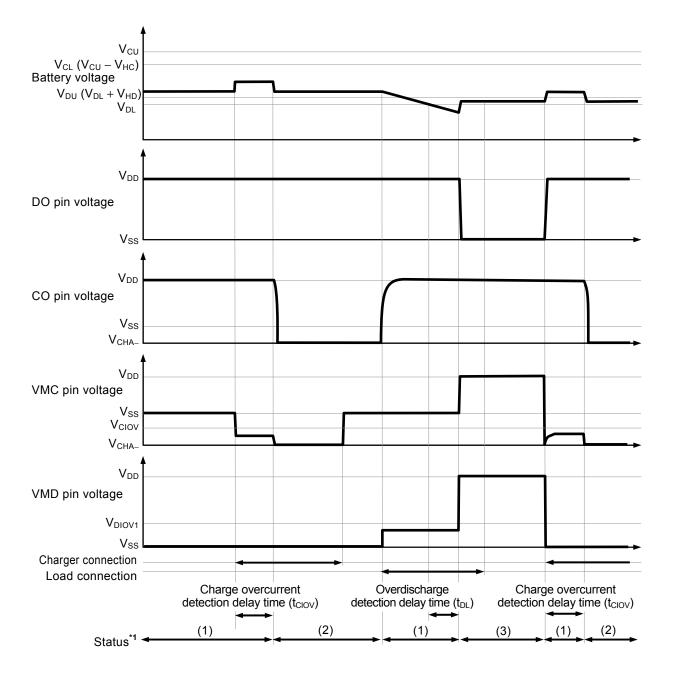
### 2. Discharge overcurrent detection

\*1. (1) : Normal status

(2) : Discharge overcurrent status

Remark The charger is assumed to charge with a constant current.

Figure 10



### 3. Charge overcurrent detection

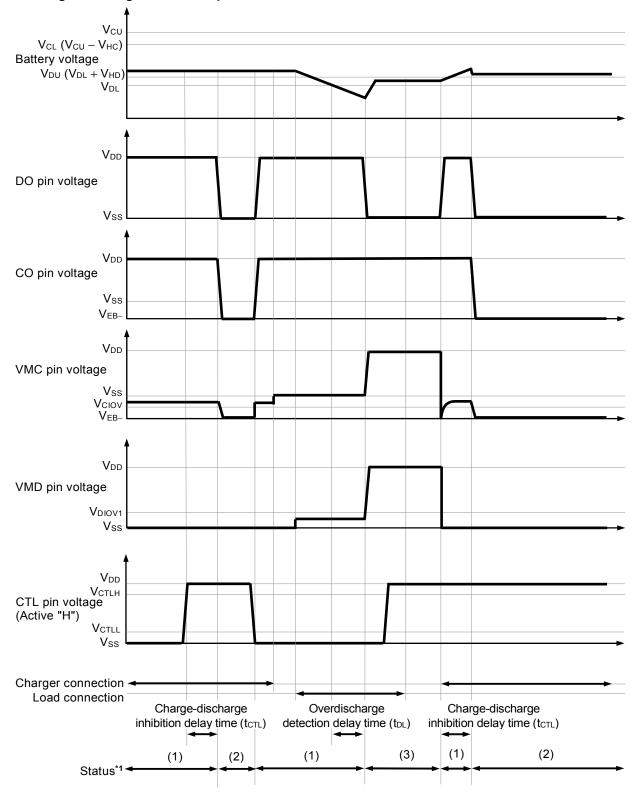
\*1. (1) : Normal status

(2) : Charge overcurrent status

(3): Overdischarge status

Remark The charger is assumed to charge with a constant current.

Figure 11



#### 4. Charge-discharge inhibition operation

\*1. (1): Normal status

(2): Charge-discharge inhibition status

(3): Overdischarge status

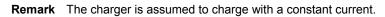


Figure 12

## Battery Protection IC Connection Example

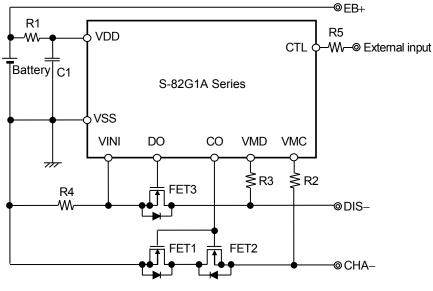


Figure 13

Table 12 Constants for Externa	al Components
--------------------------------	---------------

Symbol	Part	Purpose	Min.	Тур.	Max.	Remark
FET1	N-channel MOS FET	Charge control	_	_	-	Threshold voltage ≤ Overdischarge detection voltage <sup>*1</sup>
FET2	N-channel MOS FET	Charge control	-	_	-	Threshold voltage ≤ Overdischarge detection voltage <sup>*1</sup>
FET3	N-channel MOS FET	Discharge control	_	_	-	Threshold voltage ≤ Overdischarge detection voltage <sup>*1</sup>
R1	Resistor	ESD protection, protection for power fluctuation	270 Ω	330 Ω	1.2 kΩ <sup>*2</sup>	_
C1	Capacitor	Protection for power fluctuation	0.068 μF	0.1 μF	2.2 μF	-
R2	Resistor	ESD protection, Protection for reverse connection of a charger	300 Ω	470 Ω	1.5 kΩ	-
R3	Resistor	ESD protection, Protection for reverse connection of a charger	300 Ω	470 Ω	1.5 kΩ	_
R4	Resistor	Discharge overcurrent detection	_	3 mΩ	-	_
R5	Resistor	CTL pin input protection	_	1 kΩ	_	_

\*1. If a FET with a threshold voltage equal to or higher than the overdischarge detection voltage is used, discharging may be stopped before overdischarge is detected.

\*2. Accuracy of overcharge detection voltage is guaranteed by R1 = 330  $\Omega$ . Connecting resistors with other values will worsen the accuracy.

Caution 1. The above constants may be changed without notice.

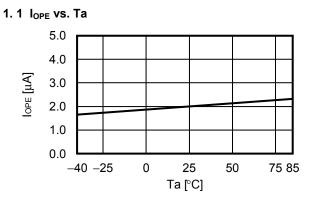
2. It has not been confirmed whether the operation is normal or not in circuits other than the above example of connection. In addition, the example of connection shown above and the constants do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constants.

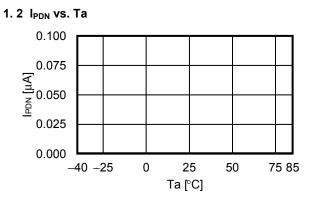
### Precautions

- The application conditions for the input voltage, output voltage, and load current should not exceed the power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- ABLIC Inc., claims no responsibility for any and all disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

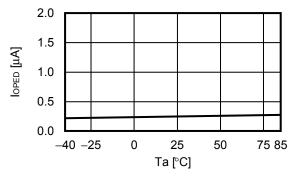
## ■ Characteristics (Typical Data)

### 1. Current consumption



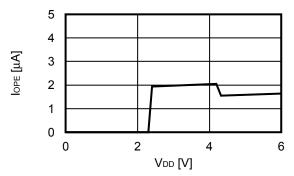


1. 3 I<sub>OPED</sub> vs. Ta

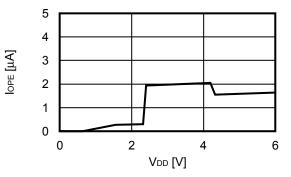


1.4 IOPE VS. VDD

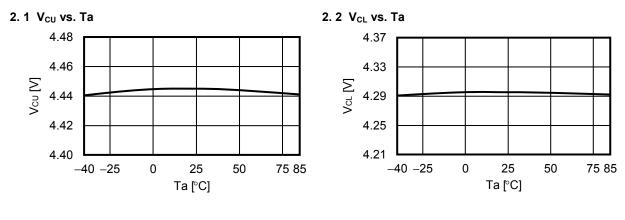
1.4.1 With power-down function

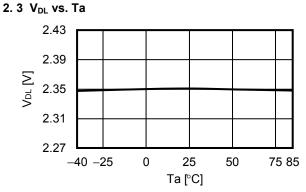


1. 4. 2 Without power-down function

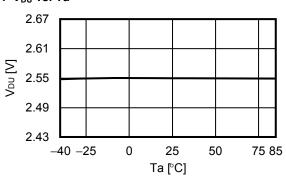


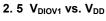
2. Detection voltage

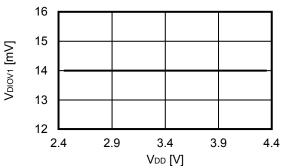


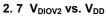


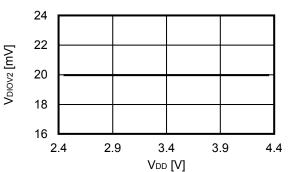
2.4 V<sub>DU</sub> vs. Ta



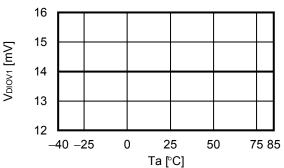


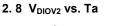


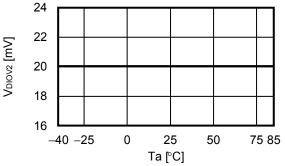




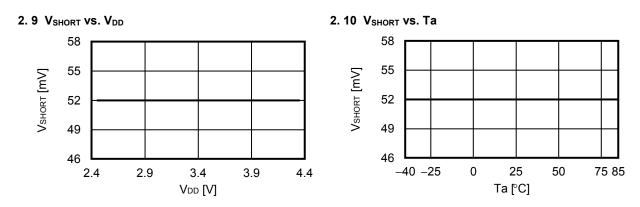
2.6 V<sub>DIOV1</sub> vs. Ta

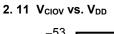




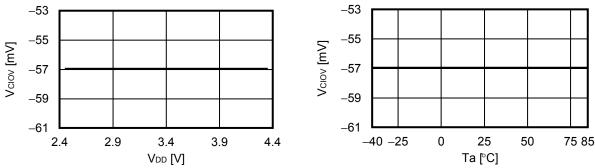


#### CHARGE-DISCHARGE CURRENT PATH SEPARATION CIRCUIT COMPATIBLE BATTERY PROTECTION IC FOR 1-CELL PACK S-82G1A Series Rev.1.0\_00



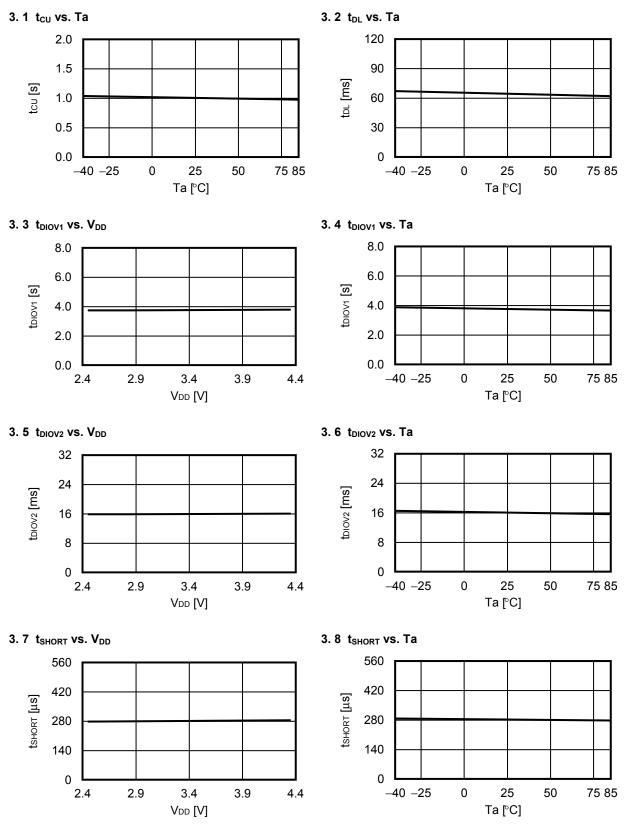




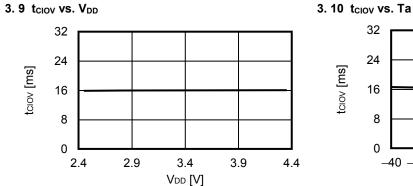


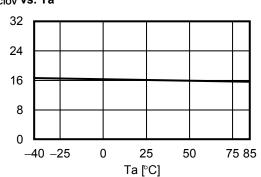
## CHARGE-DISCHARGE CURRENT PATH SEPARATION CIRCUIT COMPATIBLE BATTERY PROTECTION IC FOR 1-CELL PACK Rev.1.0\_00 S-82G1A Series

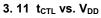
#### 3. Delay time

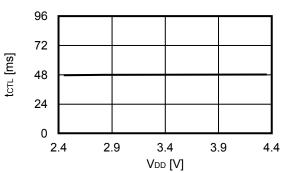


#### CHARGE-DISCHARGE CURRENT PATH SEPARATION CIRCUIT COMPATIBLE BATTERY PROTECTION IC FOR 1-CELL PACK S-82G1A Series Rev.1.0\_00

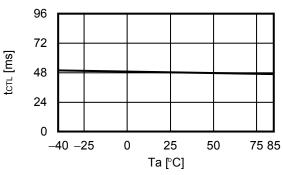




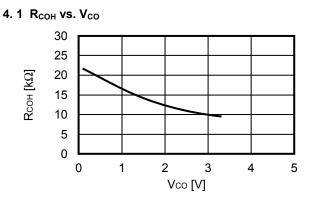


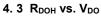


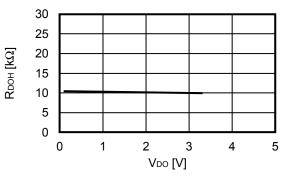




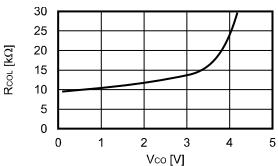
### 4. Output resistance

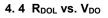


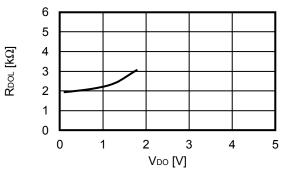




4. 2 R<sub>COL</sub> vs. V<sub>CO</sub>

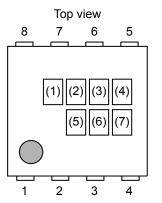






## Marking Specifications

### 1. HSNT-8(1616)



(1): (2) to (4): (5) to (7): Blank

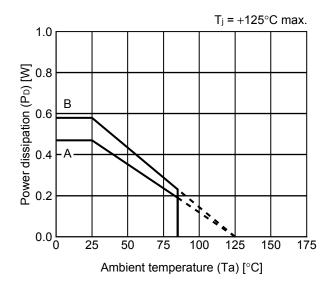
Product code (refer to **Product name vs. Product code**) Lot number

#### Product name vs. Product code

Product Name	Product Code			
Product Name	(2)	(3)	(4)	
S-82G1AAA-A8T2U	7	J	Α	

## Power Dissipation

### HSNT-8(1616)

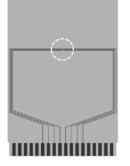


Board	Power Dissipation (P <sub>D</sub> )
A	0.47 W
В	0.58 W
С	_
D	_
E	_

## HSNT-8(1616) Test Board

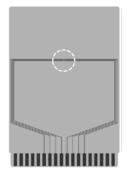
## 🔵 IC Mount Area

## (1) Board A



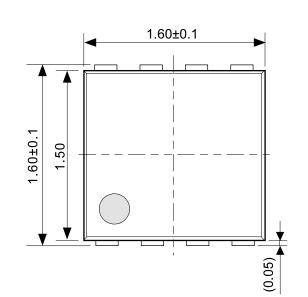
Item		Specification	
Size [mm]		114.3 x 76.2 x t1.6	
Material		FR-4	
Number of copper foil layer		2	
	1	Land pattern and wiring for testing: t0.070	
Coppor foil lover [mm]	2	-	
Copper foil layer [mm]	3	-	
	4	74.2 x 74.2 x t0.070	
Thermal via		-	

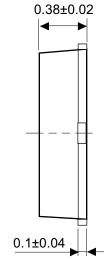
## (2) Board B

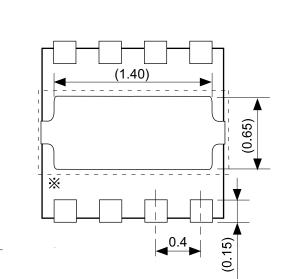


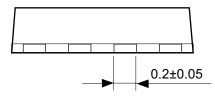
Item		Specification		
Size [mm]		114.3 x 76.2 x t1.6		
Material		FR-4		
Number of copper foil layer		4		
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070		
	2	74.2 x 74.2 x t0.035		
	3	74.2 x 74.2 x t0.035		
	4	74.2 x 74.2 x t0.070		
Thermal via		-		

No. HSNT8-B-Board-SD-1.0





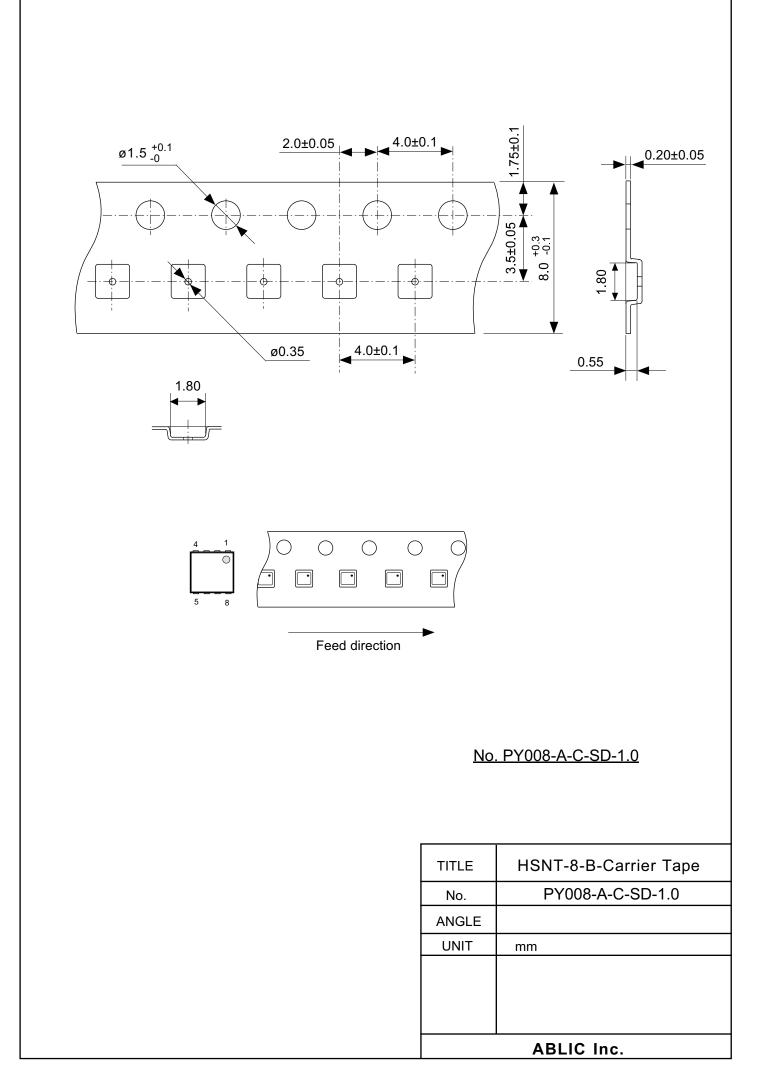


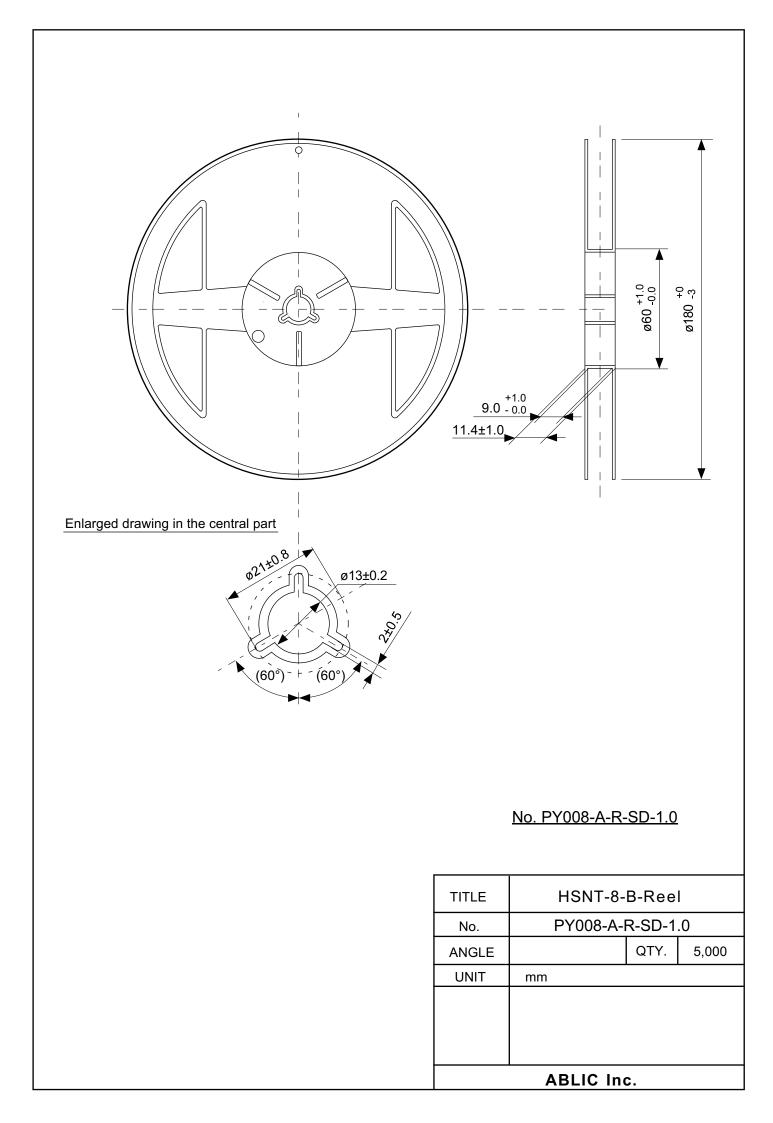


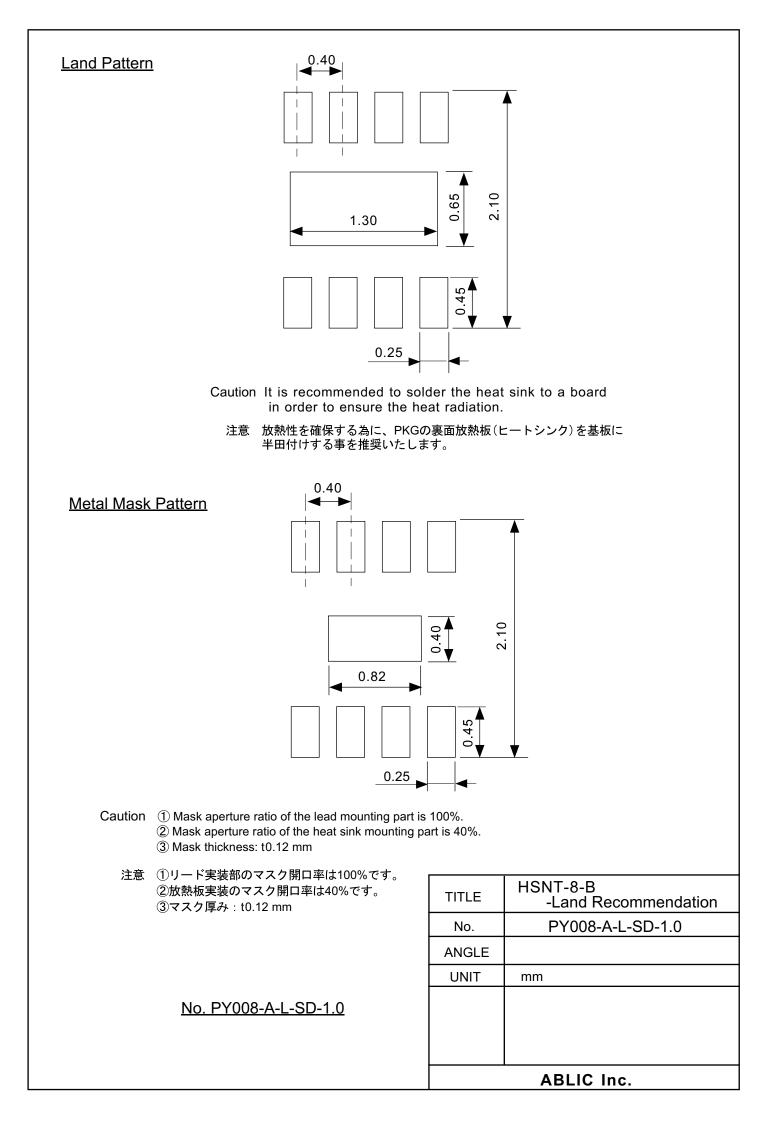
The heat sink of back side has different electric potential depending on the product.
 Confirm specifications of each product.
 Do not use it as the function of electrode.

No. PY008-A-P-SD-1.0

TITLE	HSNT-8-B-PKG Dimensions		
No.	PY008-A-P-SD-1.0		
ANGLE	$\oplus$		
UNIT	mm		
	ABLIC Inc.		







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2.4-2019.07